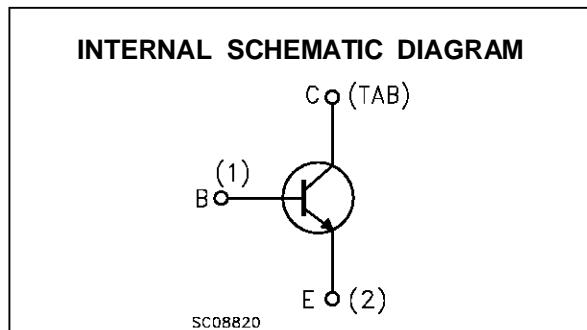
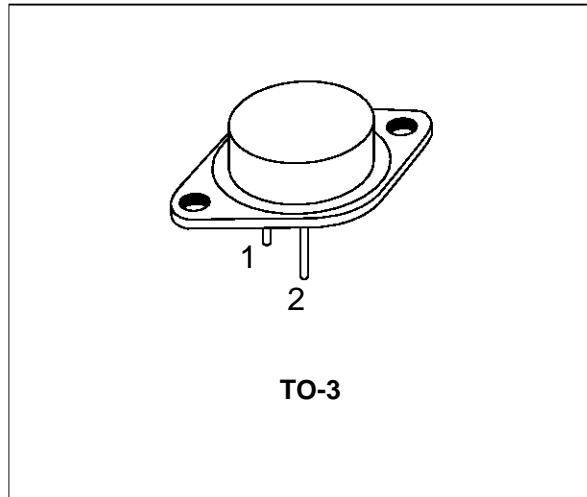


## HIGH CURRENT NPN SILICON TRANSISTOR

- SGS-THOMSON PREFERRED SALES TYPE

**DESCRIPTION**

The BUX41 is a silicon multiepitaxial planar NPN transistor in Jedec TO-3 metal case, intended for use in switching and linear applications in military and industrial equipment.


**ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter	Value	Unit
$V_{CBO}$	Collector-base Voltage ( $I_E = 0$ )	250	V
$V_{CEX}$	Collector-emitter Voltage ( $V_{BE} = -1.5V$ )	250	V
$V_{CEO}$	Collector-emitter Voltage ( $I_B = 0$ )	200	V
$V_{EBO}$	Emitter-base Voltage ( $I_C = 0$ )	7	V
$I_C$	Collector Current	15	A
$I_{CM}$	Collector Peak Current ( $t_P = 10 \text{ ms}$ )	20	A
$I_B$	Base Current	3	A
$P_{tot}$	Total Power Dissipation at $T_{case} \leq 25^\circ\text{C}$	120	W
$T_{stg}$	Storage Temperature	-65 to 200	°C
$T_j$	Max Operating Junction Temperature	200	°C

## BUX41

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### THERMAL DATA

$R_{\text{thj-case}}$	Thermal Resistance Junction-case	Max	1.46	$^{\circ}\text{C/W}$
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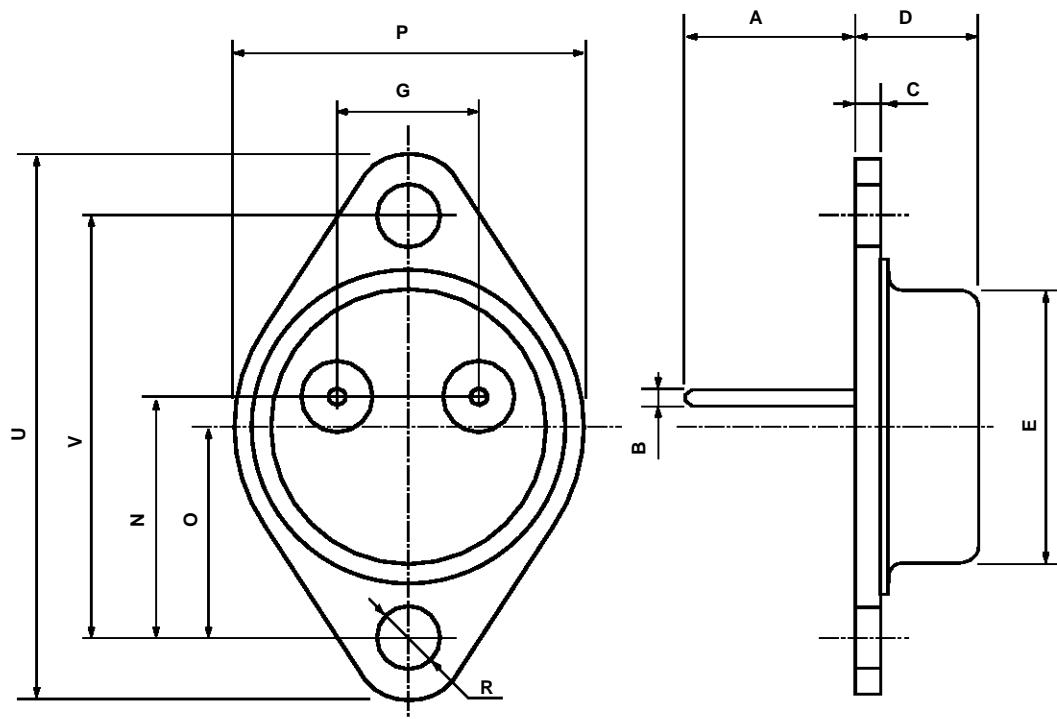
### ELECTRICAL CHARACTERISTICS ( $T_{\text{case}} = 25 \ ^{\circ}\text{C}$ unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$I_{\text{CEO}}$	Collector Cut-off Current ( $I_B = 0$ )	$V_{\text{CE}} = 160 \text{ V}$			1	mA
$I_{\text{CEX}}$	Collector Cut-off Current	$V_{\text{CE}} = 250 \text{ V}$ $V_{\text{BE}} = -1.5\text{V}$ $T_{\text{case}} = 125 \ ^{\circ}\text{C}$ $V_{\text{CE}} = 250 \text{ V}$ $V_{\text{BE}} = -1.5\text{V}$			1 5	mA
$I_{\text{EBO}}$	Emitter Cut-off Current ( $I_C = 0$ )	$V_{\text{EB}} = 5 \text{ V}$			1	mA
$V_{\text{CEO(sus)*}}$	Collector-Emitter Sustaining Voltage	$I_C = 200 \text{ mA}$	200			V
$V_{\text{EBO}}$	Emitter-Base Voltage ( $I_C = 0$ )	$I_E = 50 \text{ mA}$	7			V
$V_{\text{CE(sat)*}}$	Collector-Emitter Saturation Voltage	$I_C = 5 \text{ A}$ $I_B = 0.5 \text{ A}$ $I_C = 8 \text{ A}$ $I_B = 1 \text{ A}$		0.38 0.6	1.2 1.6	V
$V_{\text{BE(sat)*}}$	Base-Emitter Saturation Voltage	$I_C = 8 \text{ A}$ $I_B = 1 \text{ A}$		1.35	2	V
$h_{\text{FE}*}$	DC Current Gain	$I_C = 5 \text{ A}$ $V_{\text{CE}} = 4 \text{ V}$ $I_C = 8 \text{ A}$ $V_{\text{CE}} = 4 \text{ V}$	15 8		45	
$I_{\text{s/b}}$	Second Breakdown Collector Current	$V_{\text{CE}} = 30 \text{ V}$ $t = 1 \text{ s}$ $V_{\text{CE}} = 135 \text{ V}$ $t = 1 \text{ s}$	4 0.15			A A
$f_T$	Transistor Frequency	$V_{\text{CE}} = 15 \text{ V}$ $I_C = 1 \text{ A}$ $f = 10 \text{ MHz}$	8			MHz
$t_{\text{on}}$	Turn-on Time	$I_C = 8 \text{ A}$ $I_{B1} = 1 \text{ A}$ $V_{\text{CC}} = 150 \text{ V}$		0.28	1	$\mu\text{s}$
$t_s$ $t_f$	Storage Time Fall Time	$I_C = 8 \text{ A}$ $I_{B1} = 1 \text{ A}$ $I_{B2} = -1 \text{ A}$ $V_{\text{CC}} = 150\text{V}$		1.2 0.25	1.7 0.8	$\mu\text{s}$ $\mu\text{s}$
	Clamped Es/b Collector Current	$V_{\text{clamp}} = 200 \text{ V}$ $L = 500 \mu\text{H}$	8			A

\* Pulsed: Pulse duration = 300 $\mu\text{s}$ , duty cycle  $\leq 2 \%$

## TO-3 (H) MECHANICAL DATA

DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A		11.7			0.460	
B	0.96		1.10	0.037		0.043
C			1.70			0.066
D			8.7			0.342
E			20.0			0.787
G		10.9			0.429	
N		16.9			0.665	
P			26.2			1.031
R	3.88		4.09	0.152		0.161
U			39.50			1.555
V		30.10			1.185	



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